


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	STRUCTURE AND METHOD TO GAIN SUBSTANTIAL RELIABILITY IMPROVEMENTS IN LEAD-FREE BGAs ASSEMBLED WITH LEAD-BEARING SOLDERS	
Application Type : regular, utility		
Attorney Docket Number : FIS920040001US1		
Correspondence address:		
Customer Number:	29505	
Inventors Information:		
<u>Inventor 1:</u>		
Applicant Authority Type:	Inventor	
Citizenship:	US	
Given Name:	Mukta	
Middle Name:	G.	
Family Name:	Farooq	
Residence:		
City of Residence:	Hopewell Junction	
State of Residence:	NY	
Country of Residence:	US	
Address-1 of Mailing Address:	Six Dartrantra Drive	
Address-2 of Mailing Address:		
City of Mailing Address:	Hopewell Junction	
State of Mailing Address:	NY	
Postal Code of Mailing Address:	12533	
Country of Mailing Address:	US	
Phone:		
Fax:		
E-mail:		
<u>Inventor 2:</u>		
Applicant Authority Type:	Inventor	
Citizenship:	US	
Given Name:	Charles	

Middle Name: C.
Family Name: Goldsmith
Residence:
City of Residence: Poughkeepsie
State of Residence: NY
Country of Residence: US
Address-1 of Mailing Address: Three Scott Court
Address-2 of Mailing Address:
City of Mailing Address: Poughkeepsie
State of Mailing Address: NY
Postal Code of Mailing Address: 12601
Country of Mailing Address: US
Phone:
Fax:
E-mail:

Attorney Information:

practitioner(s) at Customer Number:
29505



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Assignee 1:

Organization Name: International Business Machines Corporation
Address-1 of Mailing Address: New Orchard Road
Address-2 of Mailing Address:
City of Mailing Address: Armonk
State of Mailing Address: NY
Postal Code of Mailing Address: 10504
Country of Mailing Address: US
Phone:
Fax:
E-mail: